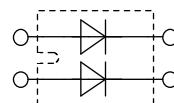


HiPerFRED

High Performance Fast Recovery Diode
Low Loss and Soft Recovery
Parallel legs

Part number

DSEP2x61-06A



Backside: isolated

E72873

Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low I_{rm} -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low I_{rm} reduces:
 - Power dissipation within the diode
 - Turn-on loss in the commutating switch

Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

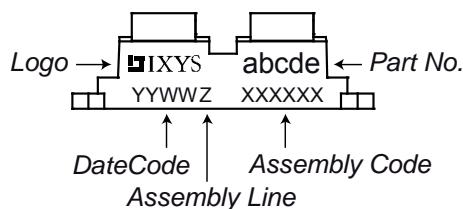
Package:

- Housing: SOT-227B (minibloc)
- Industry standard outline
- Cu base plate internal DCB isolated
- Isolation Voltage 3000 V
- Epoxy meets UL 94V-0
- RoHS compliant

| Ratings | | | | | | | |
|------------|-------------------------------------|--|------------------------|------------------------|------|------|------------|
| Symbol | Definition | Conditions | | min. | typ. | max. | Unit |
| V_{RRM} | max. repetitive reverse voltage | | $T_{VJ} = 25^\circ C$ | | | 600 | V |
| I_R | reverse current | $V_R = 600 V$ | $T_{VJ} = 25^\circ C$ | | | 650 | μA |
| | | $V_R = 600 V$ | $T_{VJ} = 150^\circ C$ | | | 2.5 | mA |
| V_F | forward voltage | $I_F = 60 A$ | $T_{VJ} = 25^\circ C$ | | | 2.01 | V |
| | | $I_F = 120 A$ | | | | 2.27 | V |
| | | $I_F = 60 A$ | $T_{VJ} = 150^\circ C$ | | | 1.35 | V |
| | | $I_F = 120 A$ | | | | 1.63 | V |
| I_{FAV} | average forward current | rectangular | $d = 0.5$ | $T_c = 65^\circ C$ | | 60 | A |
| V_{FO} | threshold voltage | $\left. \begin{array}{l} \text{slope resistance} \\ \text{for power loss calculation only} \end{array} \right\}$ | | $T_{VJ} = 150^\circ C$ | | 1.09 | V |
| r_F | slope resistance | | | | | 4.3 | $m\Omega$ |
| R_{thJC} | thermal resistance junction to case | | | | | 0.85 | K/W |
| T_{VJ} | virtual junction temperature | | | -40 | | 150 | $^\circ C$ |
| P_{tot} | total power dissipation | | | | | 140 | W |
| I_{FSM} | max. forward surge current | $t = 10 \text{ ms } (50 \text{ Hz}), \text{ sine}$ | | $T_{VJ} = 45^\circ C$ | | 600 | A |
| I_{RM} | max. reverse recovery current | | | $T_{VJ} = 25^\circ C$ | | 18 | A |
| | | $I_F = 60 A; V_R = 300 V$ | | $T_{VJ} = 100^\circ C$ | | 30 | A |
| t_{rr} | reverse recovery time | $-di_F/dt = 600 A/\mu s$ | | $T_{VJ} = 25^\circ C$ | | 30 | ns |
| | | | | $T_{VJ} = 100^\circ C$ | | 55 | ns |
| C_J | junction capacitance | $V_R = 400 V; f = 1 \text{ MHz}$ | | $T_{VJ} = 25^\circ C$ | | 67 | pF |

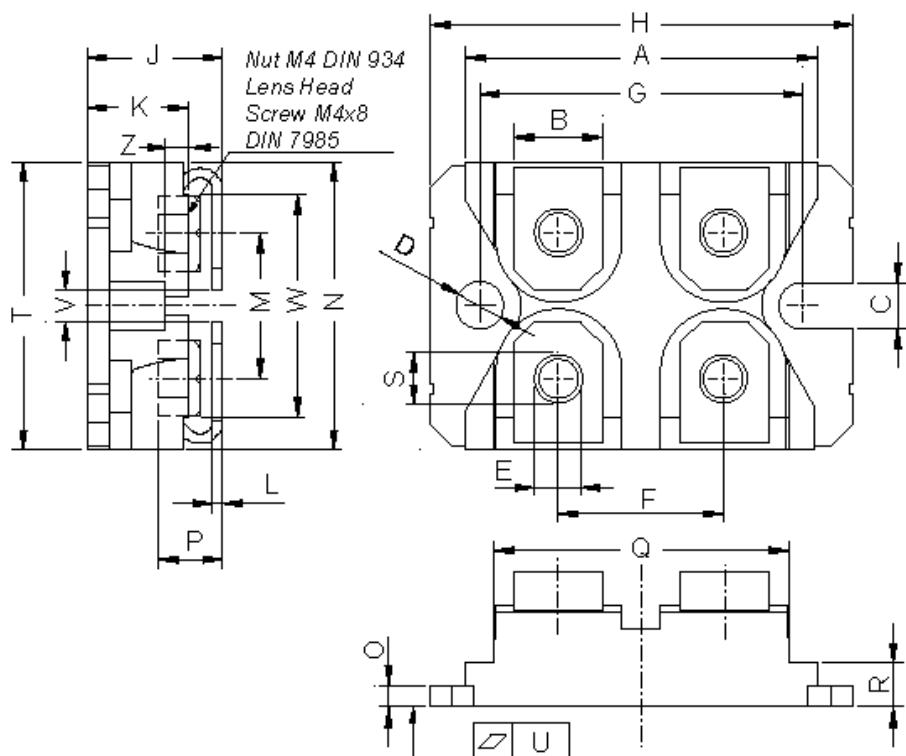
| Symbol | Definition | Conditions | Ratings | | | |
|----------------------|---|------------------------------|---------|------|------|-----|
| | | | min. | typ. | max. | |
| I _{RMS} | RMS current | per terminal | | | 100 | A |
| R _{thCH} | thermal resistance case to heatsink | | | 0.10 | | K/W |
| T _{stg} | storage temperature | | -40 | | 150 | °C |
| Weight | | | | 30 | | g |
| M _D | mounting torque | | | 1.1 | | Nm |
| M _T | terminal torque | | | 1.1 | | Nm |
| V _{ISOL} | isolation voltage | t = 1 second t = 1 minute | 3000 | | | V |
| d _{Spp/App} | creepage striking distance on surface through air | terminal to terminal | 10.5 | 3.2 | | mm |
| d _{Spb/Apb} | creepage striking distance on surface through air | terminal to backside | 8.6 | 6.8 | | mm |

Product Marking



| Ordering | Part Name | Marking on Product | Delivering Mode | Base Qty | Code Key |
|----------|--------------|--------------------|-----------------|----------|----------|
| Standard | DSEP2x61-06A | DSEP2x61-06A | Tube | 10 | 474754 |

Outlines SOT-227B (minibloc)



| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|-------|
| | min | max | min | max |
| A | 31.50 | 31.88 | 1.240 | 1.255 |
| B | 7.80 | 8.20 | 0.307 | 0.323 |
| C | 4.09 | 4.29 | 0.161 | 0.169 |
| D | 4.09 | 4.29 | 0.161 | 0.169 |
| E | 4.09 | 4.29 | 0.161 | 0.169 |
| F | 14.91 | 15.11 | 0.587 | 0.595 |
| G | 30.12 | 30.30 | 1.186 | 1.193 |
| H | 37.80 | 38.23 | 1.488 | 1.505 |
| J | 11.68 | 12.22 | 0.460 | 0.481 |
| K | 8.92 | 9.60 | 0.351 | 0.378 |
| L | 0.74 | 0.84 | 0.029 | 0.033 |
| M | 12.50 | 13.10 | 0.492 | 0.516 |
| N | 25.15 | 25.42 | 0.990 | 1.001 |
| O | 1.95 | 2.13 | 0.077 | 0.084 |
| P | 4.95 | 6.20 | 0.195 | 0.244 |
| Q | 26.54 | 26.90 | 1.045 | 1.059 |
| R | 3.94 | 4.42 | 0.155 | 0.167 |
| S | 4.55 | 4.85 | 0.179 | 0.191 |
| T | 24.59 | 25.25 | 0.968 | 0.994 |
| U | -0.05 | 0.10 | -0.002 | 0.004 |
| V | 3.20 | 5.50 | 0.126 | 0.217 |
| W | 19.81 | 21.08 | 0.780 | 0.830 |
| Z | 2.50 | 2.70 | 0.098 | 0.106 |

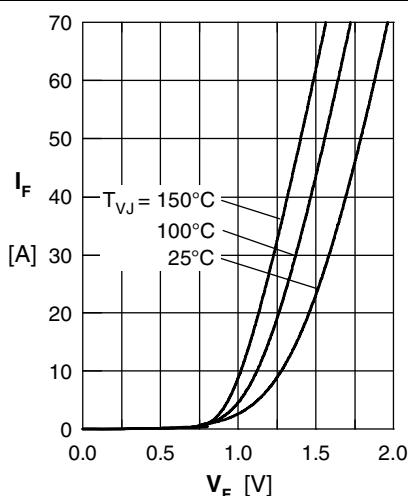
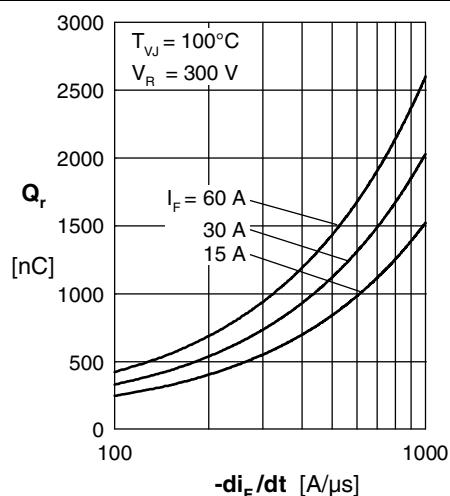
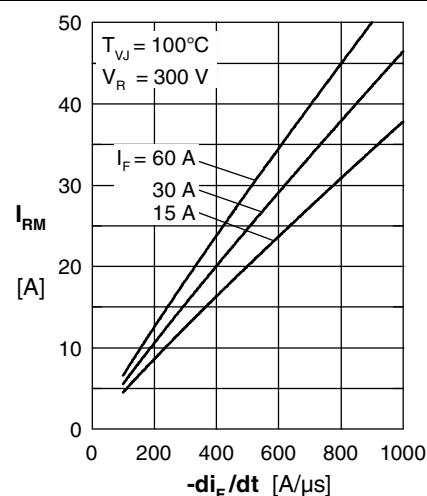
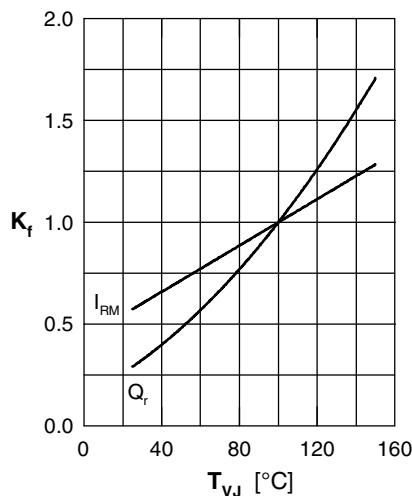
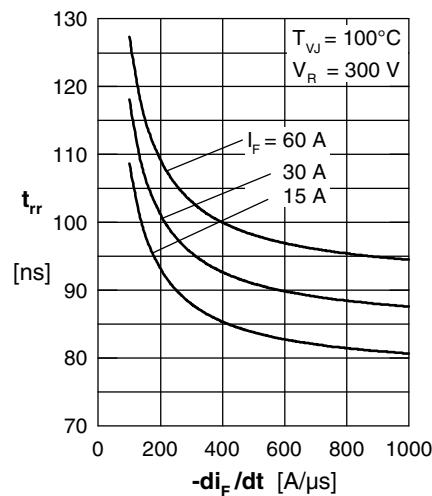
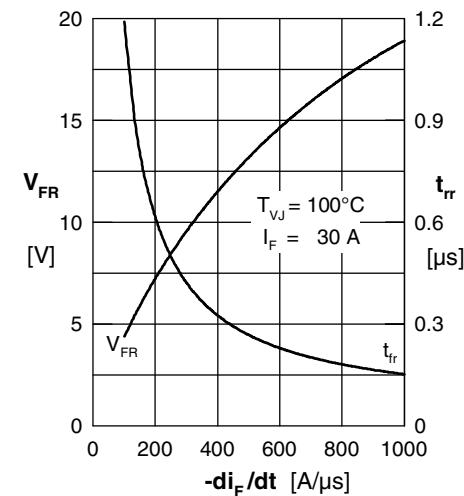
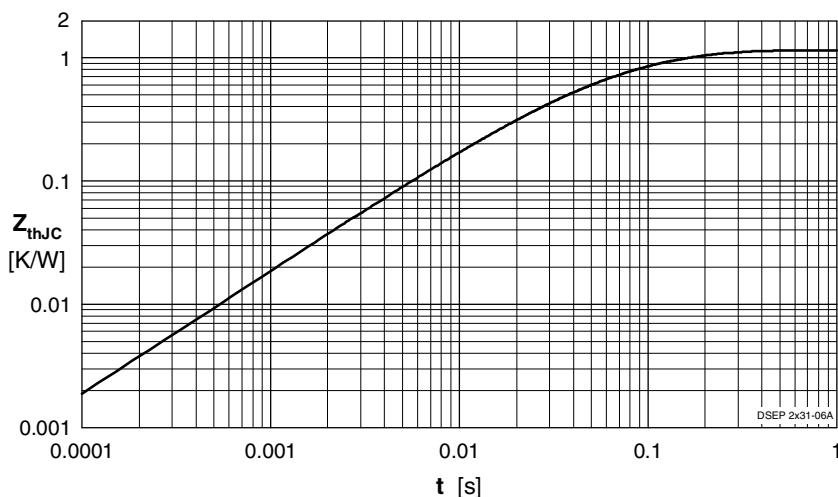
Fig. 1 Forward current I_F vs. V_F Fig. 2 Reverse recovery charge Q_r versus $-di_F/dt$ Fig. 3 Peak reverse current I_{RM} versus $-di_F/dt$ Fig. 4 Dynamic parameters Q_r , I_{RM} versus T_{VJ} Fig. 5 Recovery time t_{rr} versus $-di_F/dt$ Fig. 6 Peak forward voltage V_{FR} and t_{fr} versus $-di_F/dt$ 

Fig. 7 Transient thermal resistance junction to case

Constants for Z_{thJC} calculation:

| i | R_{thi} (K/W) | t_i (s) |
|---|-----------------------------------|-----------|
| 1 | 0.436 | 0.0055 |
| 2 | 0.482 | 0.0092 |
| 3 | 0.117 | 0.0007 |
| 4 | 0.115 | 0.0418 |